查询BTA06-400BW供应商



BTA06 BW/CW BTB06 BW/CW

SNUBBERLESS TRIACS

FEATURES

- HIGH COMMUTATION : (dl/dt)c > 5A/ms without snubber
- HIGH SURGE CURRENT : ITSM = 60A
- VDRM UP TO 800V
- BTA Family : INSULATING VOLTAGE = 2500V(RMS) (UL RECOGNIZED : E81734)

DESCRIPTION

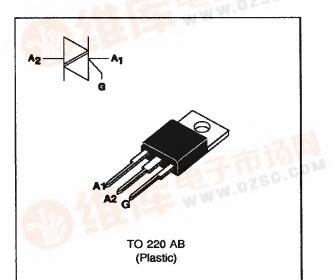
The BTA/BTB06 BW/CW triac family are high performance glass passivated chips technology. The SNUBBERLESS[™] concept offer suppression

of RC network and it is suitable for application such as phase control and static switching on inductive or resistive load.

Repetitive peak off-state voltage

Tj = 125 °C

ABSOLUTE RATINGS (limiting values)



Symbol	Parameter			Val	ue	Unit
T(RMS)	RMS on-state current	BTA	Tc = 100 °C	6	a7-1	A
	(360° conduction angle)	втв	Tc = 105 °C			150-
ITSM	Non repetitive surge peak on-state current		tp = 8.3 ms	6:	3	A
	(Tj initial = 25°C)	tp = 10 ms	60	0		
l²t	i ² t value tp = 10		tp = 10 ms	18		A ² s
dl/dt	Critical rate of rise of on-state current Gate supply : $I_G = 500 \text{ mA}$ dig/dt = 1A/µs		Repetitive F = 50 Hz	20		A/µs
WO :		Non Repetitive	100		17	
⊺stg Tj	Storage and operating junction temperature range		- 40 to + 150 - 40 to + 125		ာင္ သိ	
ТІ	Maximum lead temperature for soldering during 10 s at 4.5 mm from case			260		°C
Symbol	Parameter 400		BTA / BTB06-	BW/CW		Unit
			600	700	800	

400

600

700

800

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THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
Rth (j-a)	Junction to ambient		60	•C/W
Rth (j-c) DC	Junction to case for DC	BTA	4.4	•C/W
		втв	3.3	
Rth (j-c) AC Junction to case for 360° (F= 50 Hz)	(F= 50 Hz)	BTA	3.3	•C/W
		втв	2.5	

GATE CHARACTERISTICS (maximum values)

 $P_{G}(AV) = 1W$ $P_{GM} = 10W$ (tp = 20 µs) $I_{GM} = 4A$ (tp = 20 µs) $V_{GM} = 16V$ (tp = 20 µs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrant		Suffix		Unit
						CW	
IGT	VD=12V (DC) RL=33Ω	Tj=25°C	1-11-111	MIN	2	1	mA
				MAX	50	35	
VGT	VD=12V (DC) RL=33Ω	Tj=25°C	!-!!-!!!	MAX	1	.5	v
VGD	VD=VDRM RL=3.3kΩ	Tj=125°C	- -	MIN	0	.2	v
tgt	VD=VDRM IG = 500mA dI _G /dt = 3A/μs	Tj=25℃	1-11-111	ТҮР	:	2	μs
١L	IG=1.2 IGT	Tj=25°C	1-111	ТҮР	40	-	mA
			11	ТҮР	80	-	
			1-111	MAX	-	50	
			11	MAX	-	80]
^Ι Η *	IT= 500mA gate open	Tj=25°C		MAX	50	35	mA
V _{TM} *	I _{TM} = 8.5A tp= 380μs	Tj=25°C		MAX	1.	.75	v
DRM	V _{DRM} Rated	Tj=25°C		MAX 0.01		mA	
IRRM	VRRM Rated	Tj=125℃		MAX		2	
dV/dt *	Linear slope up to VD=67%VDRM	Tj=125°C		MIN	500	250	V/µs
	gate open			ТҮР	750	500	0
(dl/dt)c *	Without snubber	Tj=125°C		MIN	5	3.5	A/ms
				TYP	10	7]

* For either polarity of electrode A2 voltage with reference to electrode A1.



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ORDERING INFORMATION

Package	T(RMS)	VDRM / VRRM	Sensitivity Specification		
	A	v	BW	CW	
BTA (Insulated)	6	400	x	x	
		600	X	X	
		700	X	x	
		800	х	x	
BTB		400	x	x	
(Uninsulated)		600	X	x	
		700	X	x	
		800	X	x	

Fig.1 : Maximum RMS power dissipation versus RMS on-state current (F=50Hz).

(Curves are cut off by (dl/dt)c limitation)

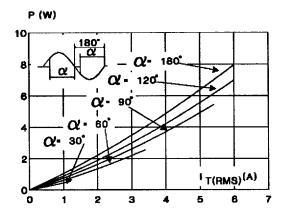
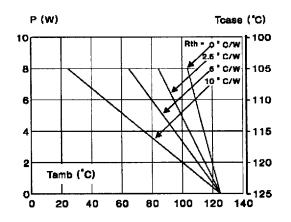


Fig.3 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (BTB).



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Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{Case}) for different thermal resistances heatsink + contact (BTA).

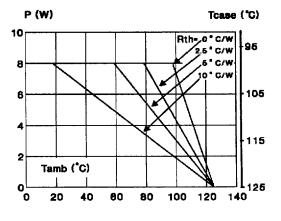
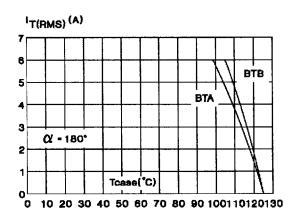


Fig.4 : RMS on-state current versus case temperature.



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Fig.5 : Relative variation of thermal impedance versus pulse duration.

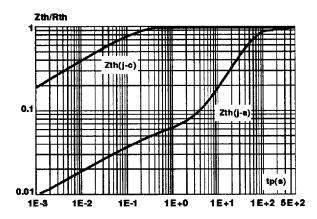


Fig.7 : Non Repetitive surge peak on-state current versus number of cycles.

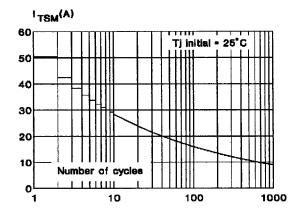


Fig.9 : On-state characteristics (maximum values).

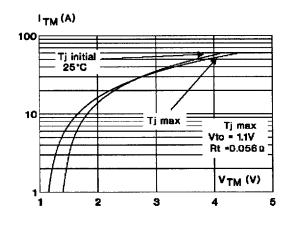


Fig.6 : Relative variation of gate trigger current and holding current versus junction temperature.

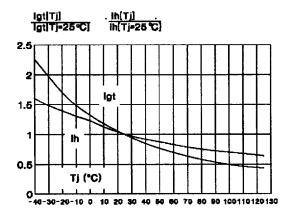
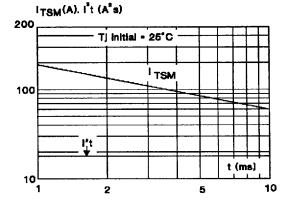


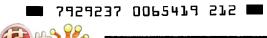
Fig.8: Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \le 10ms$, and corresponding value of l^2t .





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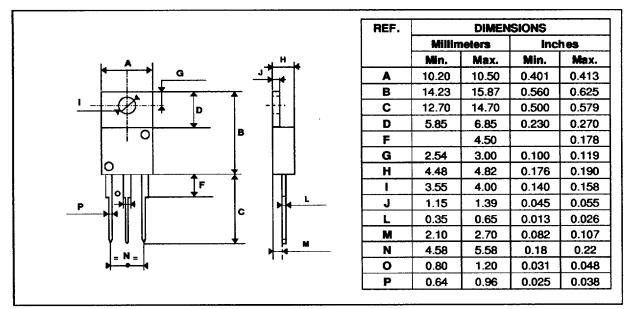


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PACKAGE MECHANICAL DATA

TO220AB Plastic



Cooling method : C Marking : type number Weight : 2.3 g Recommended torque value : 0.8 m.N. Maximum torque value : 1 m.N.

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